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To the Honorable Commissioner of Patents and Trademarks, U.S. Patent and Trademark Office, Washington, D.C. 20231
and original documents or copy thereof.

1. Name of conveying party(ies):

Gregory D. Miller
Mike Bruner

08/28/02

Additional name of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: Silicon Light Machines, Inc.

Internal Address:

Street Address: 385 Moffett Park Drive

Suite 115

City: Sunnyvale State: CA Zip: 94089

Additional Name(s) & address(es) attached? ☐ Yes ☒ No

U.S. PTO
10/23/02
08/28/02

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: July 26, and August 13, 2002

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

July 26, and August 13, 2002

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning this document should be mailed:

Name: OKAMOTO & BENEDICTO, LLP

Internal Address:

09/04/2002 FOLDER 00000013 10231357

02 FC:541

40.00 DP

Street Address: P. O. Box 641330

City: San Jose State: CA Zip: 95164

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41) \$ 40.00

- ☒ Enclosed
☐ Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

James K. Okamoto, Reg No. 40,110
Name of Person Signing

Signature

August 28, 2002
Date

Total number of pages including cover sheet, attachments, and documents: 5

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, the person(s) named below (referred herein as "INVENTOR" whether singular or plural) has sold, assigned, and transferred and does hereby sell, assign, and transfer to **Silicon Light Machines, Inc.**, a Delaware corporation, having a place of business at **385 Moffett Park Drive, Suite 115, Sunnyvale, CA. 94089**, ("ASSIGNEE"), for itself and its successors, transferees, and assignees, the following:

1. The entire worldwide right, title, and interest in all inventions and improvements ("SUBJECT MATTER") that are disclosed in the provisional application filed under 35 U.S.C. §111(b) or non-provisional application filed under 35 U.S.C. §111(a) and entitled **WAFER-LEVEL SEAL FOR NON-SILICON-BASED DEVICES** ("APPLICATION"), executed on July 26, and Aug. 13, 2002, which:

- ☒ is to be filed herewith
☐ was filed on ,
now bearing U.S. serial number; and

2. The entire worldwide right, title, and interest in and to:
(a) the APPLICATION; (b) all applications claiming priority from the APPLICATION;
(c) all divisional, continuation, substitute, renewal, reissue, and other related applications thereto which have been or may be filed in the United States or elsewhere in the world;
(d) all patents (including reissues and re-examinations) which may be granted on the applications set forth in (a), (b), (c) and (d) above; and (e) all right of priority in the APPLICATION, together with all rights to recover damages for infringement of provisional rights.

INVENTOR agrees that ASSIGNEE may apply for and receive patents for SUBJECT MATTER in ASSIGNEE's own name.

INVENTOR agrees to do the following, when requested, and without further consideration, in order to carry out the intent of this Assignment: (1) execute all assignments, oaths, powers of attorney, applications, and other papers (and/or documents) necessary or desirable to fully secure to ASSIGNEE the rights, titles and interests herein conveyed; (2) communicate to ASSIGNEE all known facts relating to the SUBJECT MATTER; and (3) generally do all lawful acts that ASSIGNEE shall consider desirable for securing, maintaining, and enforcing worldwide patent protection relating to the SUBJECT MATTER and for vesting in ASSIGNEE the rights, titles, and interests herein conveyed. INVENTOR further agrees to provide any successor, assign, or legal representative of ASSIGNEE with the benefits and assistance provided to ASSIGNEE hereunder.

INVENTOR represents that INVENTOR has the rights, titles, and interests to convey as set forth herein, and covenants with ASSIGNEE that the INVENTOR has not made and will not hereafter make any assignment, grant, mortgage, license, or other agreement affecting the rights, titles, and interests herein conveyed.


INVENTOR grants the attorney(s) of record the power to insert on this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Title of Document: ASSIGNMENT

Re:
Title: **WAFER-LEVEL SEAL FOR NON-SILICON-BASED DEVICES**
Serial No.: not yet known
Filed: (if applicable)
Attv. Docket No. **10021.000210 (P0277)**

This Assignment may be executed in one or more counterparts, each of which shall be deemed an original and all of which may be taken together as one and the same Assignment.

Name and Signature _____

Date of
Signature
Gregory D. MillerAug 13, 2002

Name and Signature _____

Date of
Signature_____
Mike Bruner

_____, 2002

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_____.2002

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Date of
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Mike Bruner7/26.2002